

Datasheet revision 1.1

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Tack Flux No-Clean in 30cc Syringe

Product Highlights

Ideal for all rework, solder, de-solder and reflow applications Non-corrosive, non-conductive, no-clean Tack flux will not run all over PCB when applied Has a pleasant odor Excellent wetting Easily cleaned with isopropyl alcohol (IPA) Attachment of BGA spheres Soldering flip chip components Long stencil life Wide process window Clear residue Can be used with Leaded and Lead-Free applications RoHS II and REACH compliant

Specifications

Flux Type: Flux Classification: Packaging: Shelf Life: Synthetic No-Clean (for Leaded and Lead-Free applications) REL0 30cc/30g Syringe Refrigerated >24 months, Unrefrigerated >24 months

Stencil Life >8 hours @ 20-50% RH 22-28°C (72-82°F) >4 hours @ 50-70% RH 22-28°C (72-82°F)

Stencil Cleaning Automated stencil cleaning systems for both stencil and misprinted boards. Manual cleaning using isopropyl alcohol (IPA).

Storage and Handling

Store refrigerated or at room temperature 3-25°C (37-77°F). Do not freeze. Allow 4 hours for flux to reach an operating temperature of 20-25°C (68-77°F) before use.

Transportation

This product has no shipping restrictions. Shipping below 0°C (32°F) or above 25°C (77°F) for normal transit times by ground or air will not impact this product's stated shelf life.

Yes Yes

Conforms to the following Industry Standards:	
J-STD-004B, Amendment 1 (Solder Fluxes):	
RoHS 2 Directive 2011/65/EU:	